2025 3rd Asia Conference on Electronics Engineering (ACEE 2025) will be held in Seoul, South Korea during April 19-21, 2025. It aims to bring together researchers in the related areas, which devoted their work to push the development of electronics engineering.







ACEE 2025 Conference Proceedings AIP Publishing

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Call for Papers

Topics include, but not limited to:

Track 1. Electronics

Track 2. Control and Computer Systems

Track 3. Telecommunication Engineering

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More Topic: https://www.acee.net/topics.html

Important Deadline

♦ March 10, 2025 ---- Submission

♦ March 20, 2025 ---- Notification

♦ March 28, 2025 ---- Registration

> Seoul, South Korea April 19-21, 2025

ACEE 2025 2025 3rd Asia Conference on Electronics Engineering

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- · Submission Guideline·
- Abstract (presentation only)
- Full paper (presentation and publication)
- Conference paper template

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第三届亚洲电子工程会议 (ACEE 2025) 将于2025年4 月19至21日在韩国·首尔召开。会议旨在汇聚相关领 域的研究人员共同推动电子工程的发展。







通过会议程序委员会审核并注册的英文论文, 将发表在在ACEE 2025会议论文集中,由AIP 进行出版, 并提交Scopus (Elsevier), CPCI (part of Web of Science), Inspec, CAS, 等检索。

会议征稿

征稿主题包含但不限于:

主题一: 电子产品

主题二:控制和计算机系统

主题三: 电信工程

主题四: 计算机工程

主体五: 成像和传感工程

更多主题: https://www.acee.net/topics.html

重要日期

- ◆ 2025/03/10 ----- 截稿日期
- ◆ 2025/03/20 ----- 通知日期
- ◆ 2025/03/28 ---- 注册截止

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- 摘要投稿 (只报告)
- 全文投稿(出版和报告)
- ◆会议论文模板

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